

**Absolute Maximum Ratings** (@T<sub>A</sub> = +25°C unless otherwise specified.)

| Characteristic            | Symbol           | Value | Unit |
|---------------------------|------------------|-------|------|
| Collector-Base Voltage    | V <sub>CBO</sub> | 75    | V    |
| Collector-Emitter Voltage | V <sub>CEO</sub> | 40    | V    |
| Emitter-Base Voltage      | V <sub>EBO</sub> | 6     | V    |
| Collector Current         | I <sub>C</sub>   | 600   | mA   |

**Thermal Characteristics** (@T<sub>A</sub> = +25°C unless otherwise specified.)

| Characteristic                                   | Symbol                            | Value       | Unit |
|--------------------------------------------------|-----------------------------------|-------------|------|
| Power Dissipation (Note 5)                       | P <sub>d</sub>                    | 200         | mW   |
| Thermal Resistance, Junction to Ambient (Note 5) | R <sub>θJA</sub>                  | 625         | °C/W |
| Operating and Storage Temperature Range          | T <sub>j</sub> , T <sub>STG</sub> | -55 to +150 | °C   |

**ESD Ratings** (Note 6)

| Characteristic                             | Symbol  | Value | Unit | JEDEC Class |
|--------------------------------------------|---------|-------|------|-------------|
| Electrostatic Discharge - Human Body Model | ESD HBM | 4,000 | V    | 3A          |
| Electrostatic Discharge - Machine Model    | ESD MM  | 400   | V    | C           |

**Electrical Characteristics** (@T<sub>A</sub> = +25°C unless otherwise specified.)

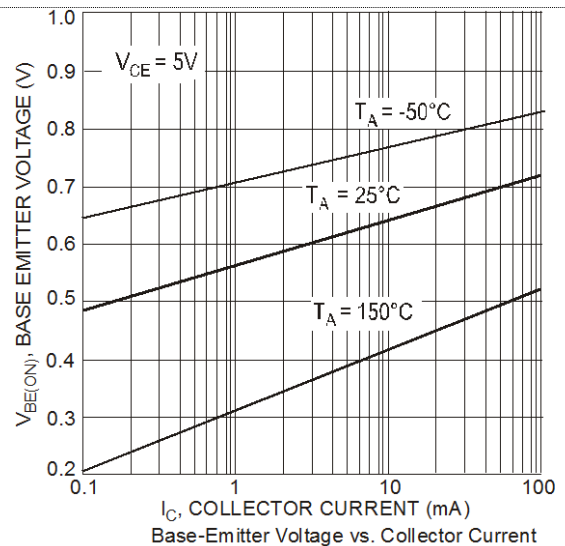
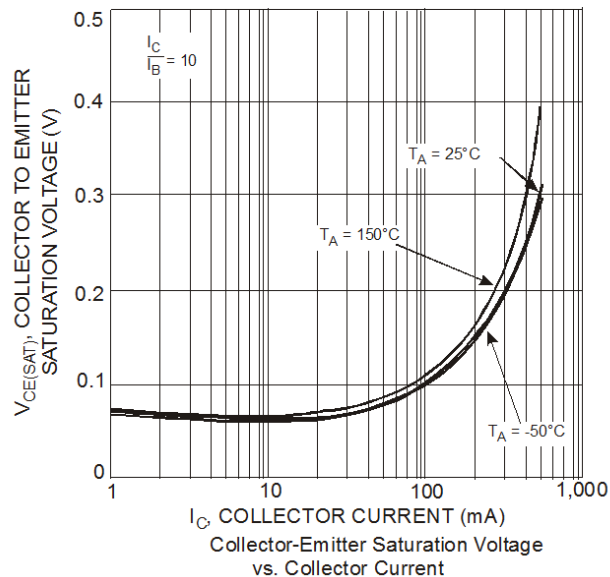
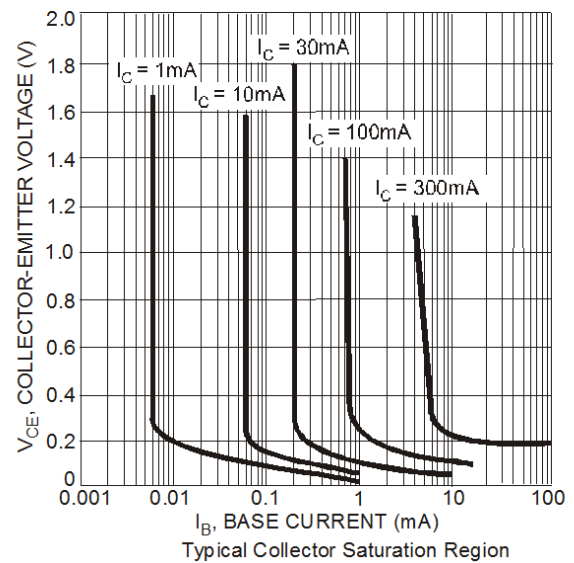
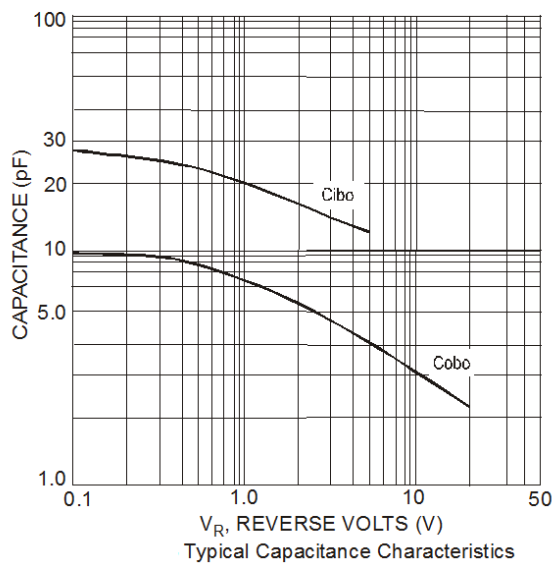
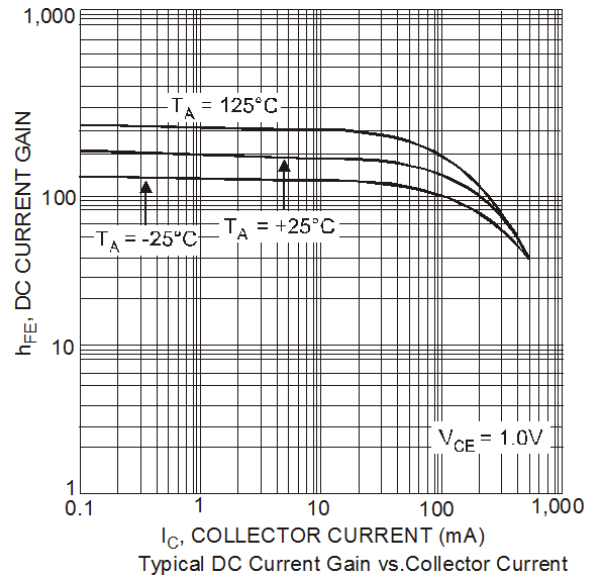
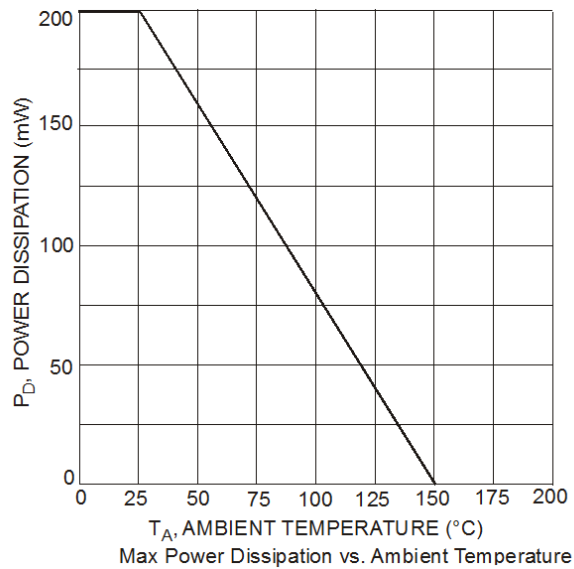
| Characteristic                       | Symbol               | Min | Max        | Unit     | Test Condition                                                                                                  |
|--------------------------------------|----------------------|-----|------------|----------|-----------------------------------------------------------------------------------------------------------------|
| <b>OFF CHARACTERISTICS (Note 7)</b>  |                      |     |            |          |                                                                                                                 |
| Collector-Base Breakdown Voltage     | BV <sub>CBO</sub>    | 75  | —          | V        | I <sub>C</sub> = 10μA, I <sub>E</sub> = 0                                                                       |
| Collector-Emitter Breakdown Voltage  | BV <sub>CEO</sub>    | 40  | —          | V        | I <sub>C</sub> = 10mA, I <sub>B</sub> = 0                                                                       |
| Emitter-Base Breakdown Voltage       | BV <sub>EBO</sub>    | 6.0 | —          | V        | I <sub>E</sub> = 10μA, I <sub>C</sub> = 0                                                                       |
| Collector Cut-Off Current            | I <sub>CBO</sub>     | —   | 10         | nA<br>μA | V <sub>CB</sub> = 60V, I <sub>E</sub> = 0<br>V <sub>CB</sub> = 60V, I <sub>E</sub> = 0, T <sub>A</sub> = +150°C |
| Collector Cut-Off Current            | I <sub>CEX</sub>     | —   | 10         | nA       | V <sub>CE</sub> = 60V, V <sub>EB(OFF)</sub> = 3V                                                                |
| Base Cutoff Current                  | I <sub>BL</sub>      | —   | 20         | nA       | V <sub>CE</sub> = 60V, V <sub>EB(OFF)</sub> = 3V                                                                |
| <b>ON CHARACTERISTICS (Note 7)</b>   |                      |     |            |          |                                                                                                                 |
| DC Current Gain                      | h <sub>FE</sub>      | 35  | —          | —        | I <sub>C</sub> = 100μA, V <sub>CE</sub> = 10V                                                                   |
|                                      |                      | 50  | —          |          | I <sub>C</sub> = 1.0mA, V <sub>CE</sub> = 10V                                                                   |
|                                      |                      | 75  | —          |          | I <sub>C</sub> = 10mA, V <sub>CE</sub> = 10V                                                                    |
|                                      |                      | 100 | 300        |          | I <sub>C</sub> = 150mA, V <sub>CE</sub> = 10V                                                                   |
|                                      |                      | 40  | —          |          | I <sub>C</sub> = 500mA, V <sub>CE</sub> = 10V                                                                   |
|                                      |                      | 50  | —          |          | I <sub>C</sub> = 10mA, V <sub>CE</sub> = 10V, T <sub>A</sub> = -55°C                                            |
|                                      |                      | 35  | —          |          | I <sub>C</sub> = 150mA, V <sub>CE</sub> = 1.0V                                                                  |
| Collector-Emitter Saturation Voltage | V <sub>CE(sat)</sub> | —   | 0.3<br>1.0 | V        | I <sub>C</sub> = 150mA, I <sub>B</sub> = 15mA<br>I <sub>C</sub> = 500mA, I <sub>B</sub> = 50mA                  |
| Base-Emitter Saturation Voltage      | V <sub>BE(sat)</sub> | 0.6 | 1.2<br>2.0 | V        | I <sub>C</sub> = 150mA, I <sub>B</sub> = 15mA<br>I <sub>C</sub> = 500mA, I <sub>B</sub> = 50mA                  |
| <b>SMALL SIGNAL CHARACTERISTICS</b>  |                      |     |            |          |                                                                                                                 |
| Output Capacitance                   | C <sub>obo</sub>     | —   | 8          | pF       | V <sub>CB</sub> = 10V, f = 1.0MHz, I <sub>E</sub> = 0                                                           |
| Input Capacitance                    | C <sub>ibo</sub>     | —   | 25         | pF       | V <sub>EB</sub> = 0.5V, f = 1.0MHz, I <sub>C</sub> = 0                                                          |
| Current Gain-Bandwidth Product       | f <sub>T</sub>       | 300 | —          | MHz      | V <sub>CE</sub> = 20V, I <sub>C</sub> = 20mA,<br>f = 1.0MHz                                                     |
| Noise Figure                         | NF                   | —   | 4.0        | dB       | V <sub>CE</sub> = 10V, I <sub>C</sub> = 100μA,<br>R <sub>S</sub> = 1kΩ, f = 1.0kHz                              |
| <b>SWITCHING CHARACTERISTICS</b>     |                      |     |            |          |                                                                                                                 |
| Delay Time                           | t <sub>d</sub>       | —   | 10         | ns       | V <sub>CC</sub> = 30V, I <sub>C</sub> = 150mA,<br>V <sub>BE(OFF)</sub> = -0.5V, I <sub>B1</sub> = 15mA          |
| Rise Time                            | t <sub>r</sub>       | —   | 25         | ns       |                                                                                                                 |
| Storage Time                         | t <sub>s</sub>       | —   | 225        | ns       | V <sub>CC</sub> = 30V, I <sub>C</sub> = 150mA,                                                                  |
| Fall Time                            | t <sub>f</sub>       | —   | 60         | ns       | I <sub>B1</sub> = I <sub>B2</sub> = 15mA                                                                        |

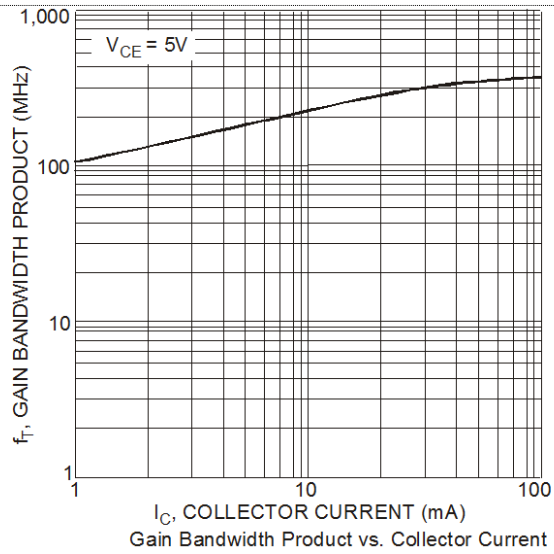
Notes: 5. For a device mounted with the collector lead on minimum recommended pad layout 1oz copper that is on a single-sided 1.6mm FR4 PCB; device is measured under still air conditions whilst operating in a steady-state.

6. Refer to JEDEC specification JESD22-A114 and JESD22-A115.

7. Measured under pulsed conditions. Pulse width ≤ 300μs. Duty cycle ≤ 2%.

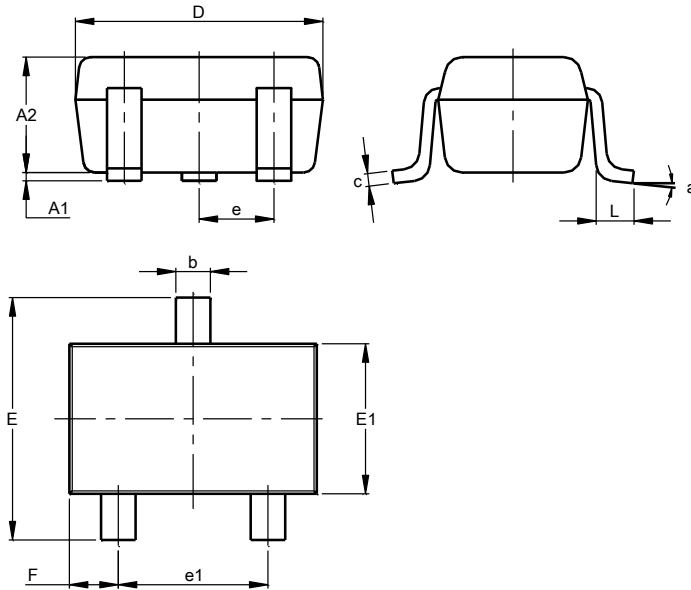
**Typical Electrical Characteristics** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)





## Package Outline Dimensions

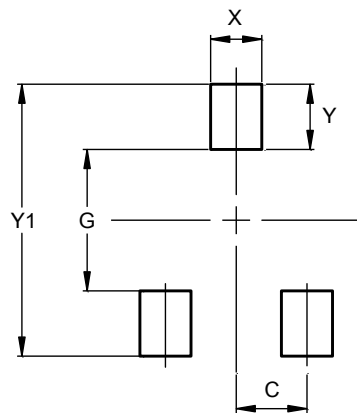
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



| SOT323               |           |       |       |
|----------------------|-----------|-------|-------|
| Dim                  | Min       | Max   | Typ   |
| A1                   | 0.00      | 0.10  | 0.05  |
| A2                   | 0.90      | 1.00  | 0.95  |
| b                    | 0.25      | 0.40  | 0.30  |
| c                    | 0.10      | 0.18  | 0.11  |
| D                    | 1.80      | 2.20  | 2.15  |
| E                    | 2.00      | 2.20  | 2.10  |
| E1                   | 1.15      | 1.35  | 1.30  |
| e                    | 0.650 BSC |       |       |
| e1                   | 1.20      | 1.40  | 1.30  |
| F                    | 0.375     | 0.475 | 0.425 |
| L                    | 0.25      | 0.40  | 0.30  |
| a                    | 8°        |       |       |
| All Dimensions in mm |           |       |       |

## Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



| Dimensions | Value (in mm) |
|------------|---------------|
| C          | 0.650         |
| G          | 1.300         |
| X          | 0.470         |
| Y          | 0.600         |
| Y1         | 2.500         |

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